

Features

- 3.6*3.1*3.1 mm SMD LED
- High Brightness
- InGaN Technology
- Viewing Angle 60 °
- High reliability
- MSL Level 3
- Water-Resistant(IPX7)

Applications

- Consumer Electronics
- Traffic lights
- Automobile After Market
- Industrial Equipment

Description

The IN-P36BTEG is a popular low profile 3631 package with versatile design capabilities. It is a PLCC type silicone style LED which can be used in various applications.

Recommended Solder Pattern

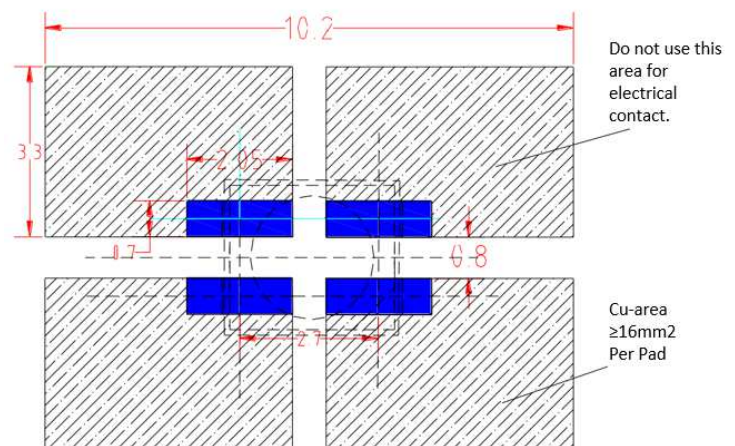


Figure 1. IN-P36BTEG Solder Pattern

Package Dimensions in mm

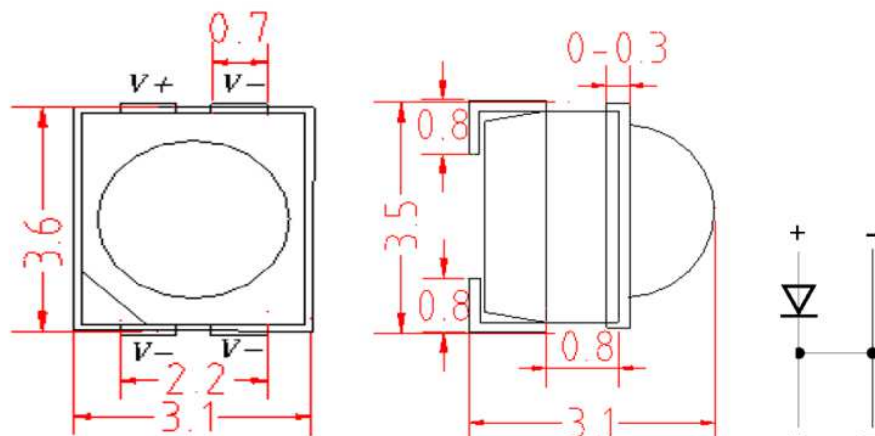


Figure 2. IN-P36BTEG Package Dimensions

*Notice: Tolerance of measurement of Dimension: $\pm 0.2\text{mm}$

Absolute Maximum Rating at 25°C

Product	Emission Color	P _d (mW)	I _{FP} * (mA)	T _j (°C)	V _R (V)	T _{OP} (°C)	T _{ST} (°C)
IN-P36BTEG	Green	95	80	125	5	-40°C~+100°C	-40°C~+100°C

*Condition for IFP is pulse of 1/10 duty and 0.1msec width

ESD Precaution

ATTENTION: Electrostatic Discharge (ESD) protection



The symbol above denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlInGaP, GaN, or/and InGaN based chips are STATIC SENSITIVE devices. ESD precaution must be taken during design and assembly. If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

Please be advised that normal static precautions should be taken in the handling and assembly of this device to prevent damage or degradation which may be induced by electrostatic discharge (ESD).

Electrical Characteristics $T_A = 25^\circ\text{C}$

Product	Emission Color	I _F (mA)	V _F (V)	Luminous Intensity(mcd)	λ(nm)	Viewing Angle	I _r (V _r = 5V)	ESD Sensitivity(V)
			Typ.	Typ.	λ _D	2 θ 1/2	μA	HBM
IN-P36BTEG	Green	30	3.0	6000	522.5	60	10	1000

*Notes: Performance guaranteed only under conditions listed in above tables.

Luminous Intensity Rank Limits (IF =30mA)

Bin Code	32	33	34	35
Flux Rank(mcd)	3000-3900	3900-5100	5100-6600	6600-8600

*Notice: Tolerance of measurement of Luminous Intensity: $\pm 12\%$

Forward Voltage Rank Limits (IF =30mA)

Bin Code	Min	Max	Unit
V2B	2.4	2.7	V
V2C	2.7	3.0	
V3A	3.0	3.3	
V3B	3.3	3.6	

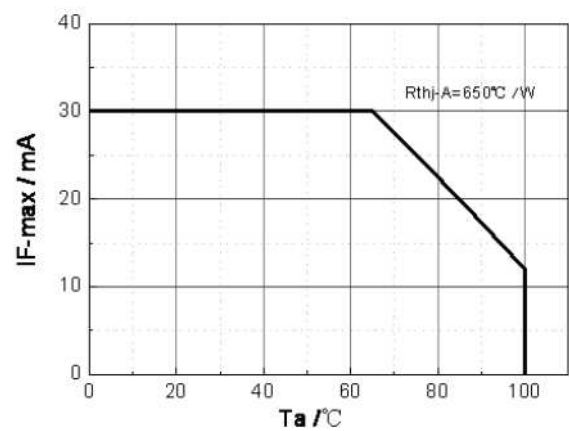
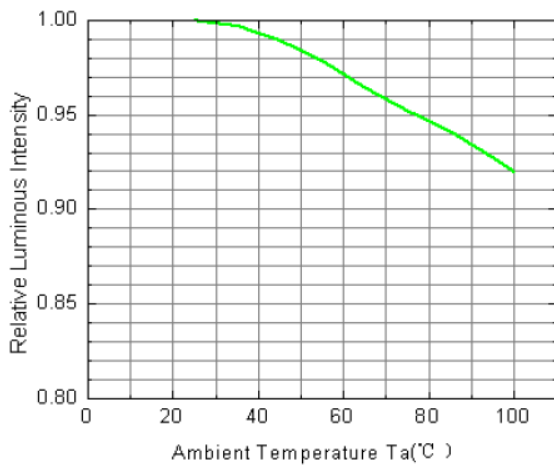
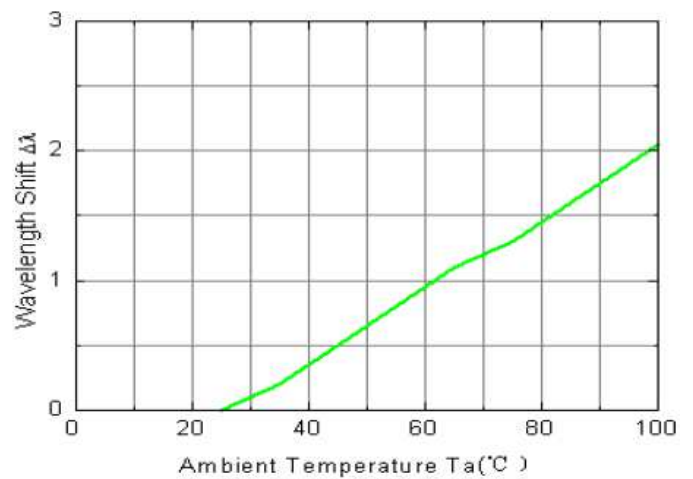
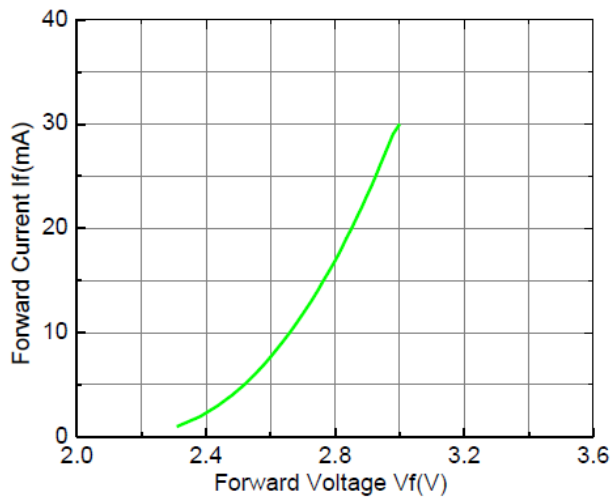
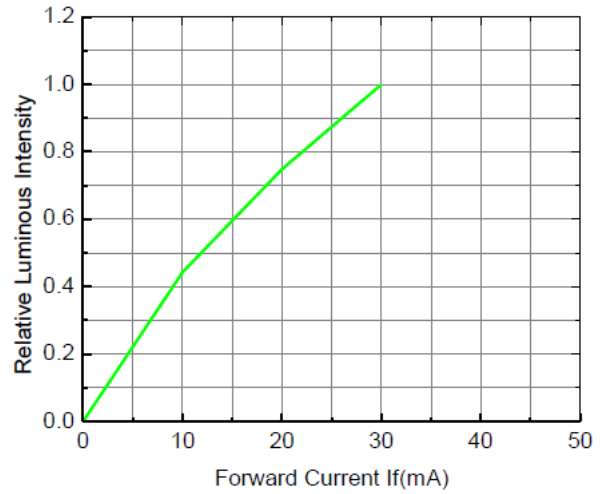
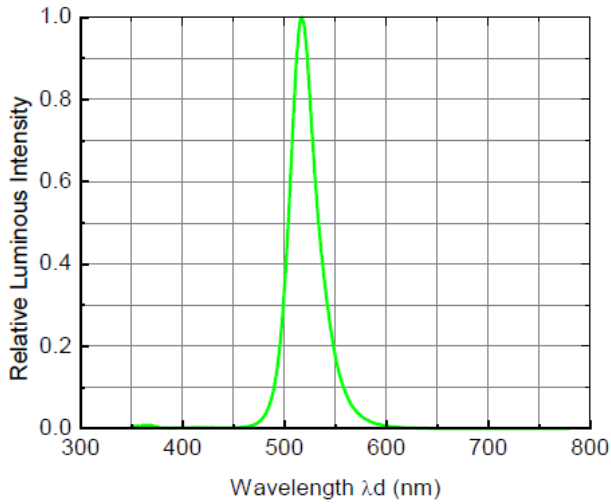
*Notice: Tolerance of measurement of Forward Voltage: $\pm 0.1V$

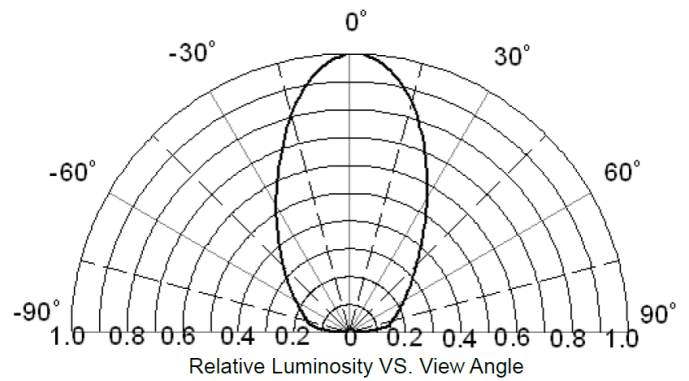
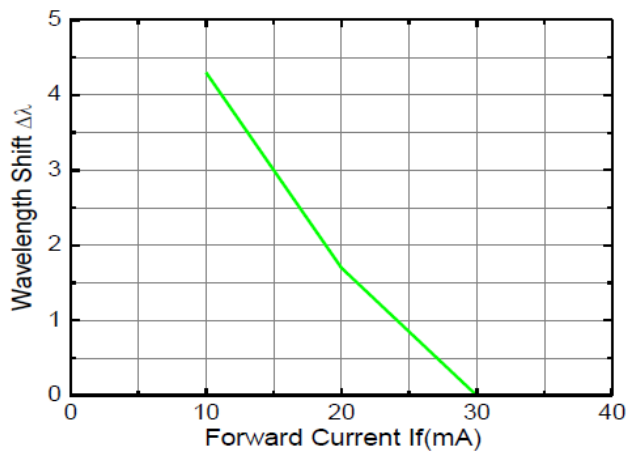
Dominant Wavelength Rank Limits (IF =30mA)

Bin Code	Min	Max	Unit
TG1	515	520	nm
TG2	520	525	
TG3	525	530	

*Notice: Tolerance of measurement of Dominant Wavelength: $\pm 1nm$

Typical Characteristic Curves





Ordering Information

Product	Emission Color	Technology	Test Current I_F (mA)	Luminous Intensity I_V (mcd) (Typ.)	Forward Voltage V_F (V) (Typ.)	Orderable Part Number
IN-P36BTEG	Green	InGaN	30	6000	3.0	IN-P36BTEG

Label Specifications

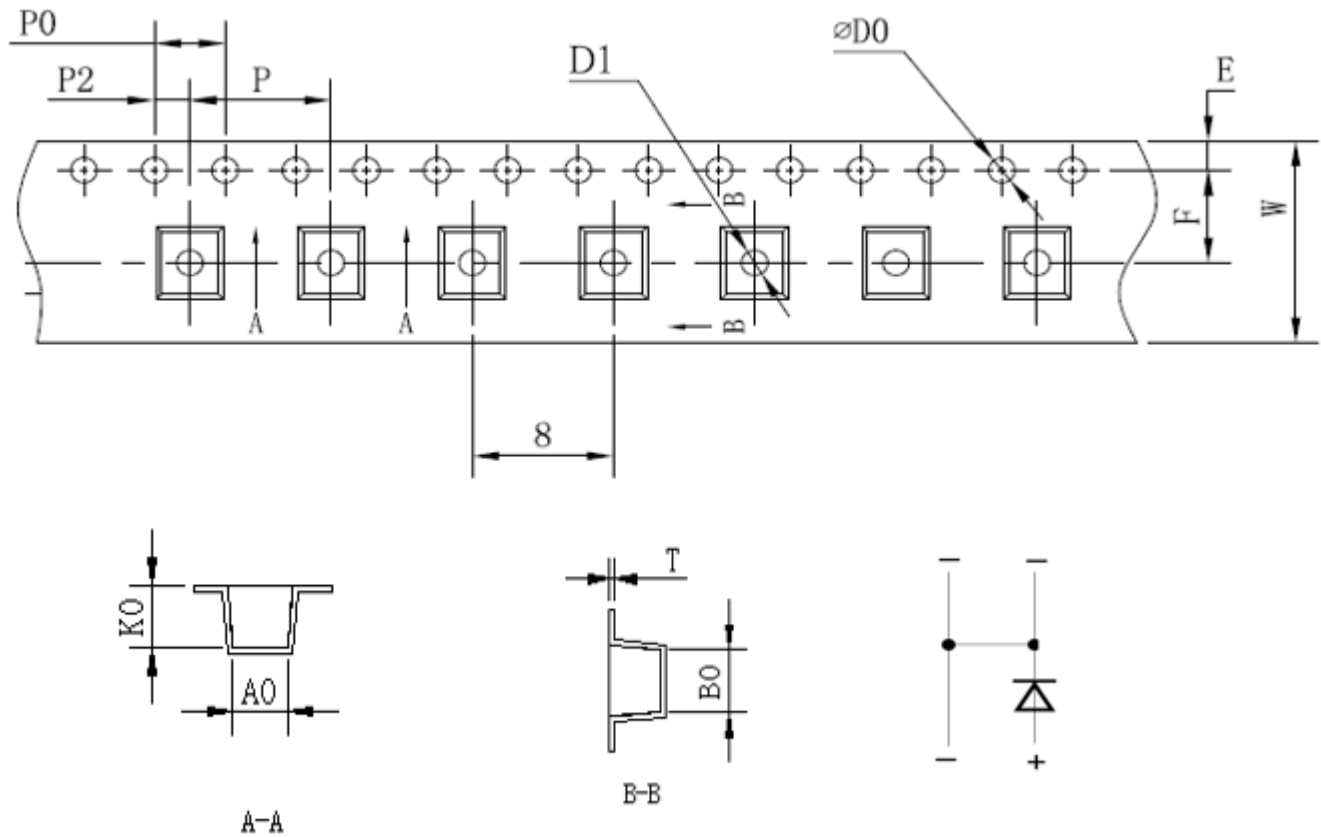
		Date: yyyy/mm/dd
CUSTOMER P/N: 		
INOLUX P/N: 	QTY: PCS 	
LOT NO: 		QC
IV BIN:	COLOR BIN:	VF:

Inolux P/N:

I	N	-	P	3	6	B	T	E		G	-	X	X	X	X
Inolux			Material	Package	Variation	Orientation	Current	Lens	Color			Customized Stamp-off			
			P = PLCC Type	36B = 3.6 x 3.1 x 3.1mm (60 Deg)		T = Top Mount	E = 30mA	(Blank) = Clear U = Diffused	G=520nm						

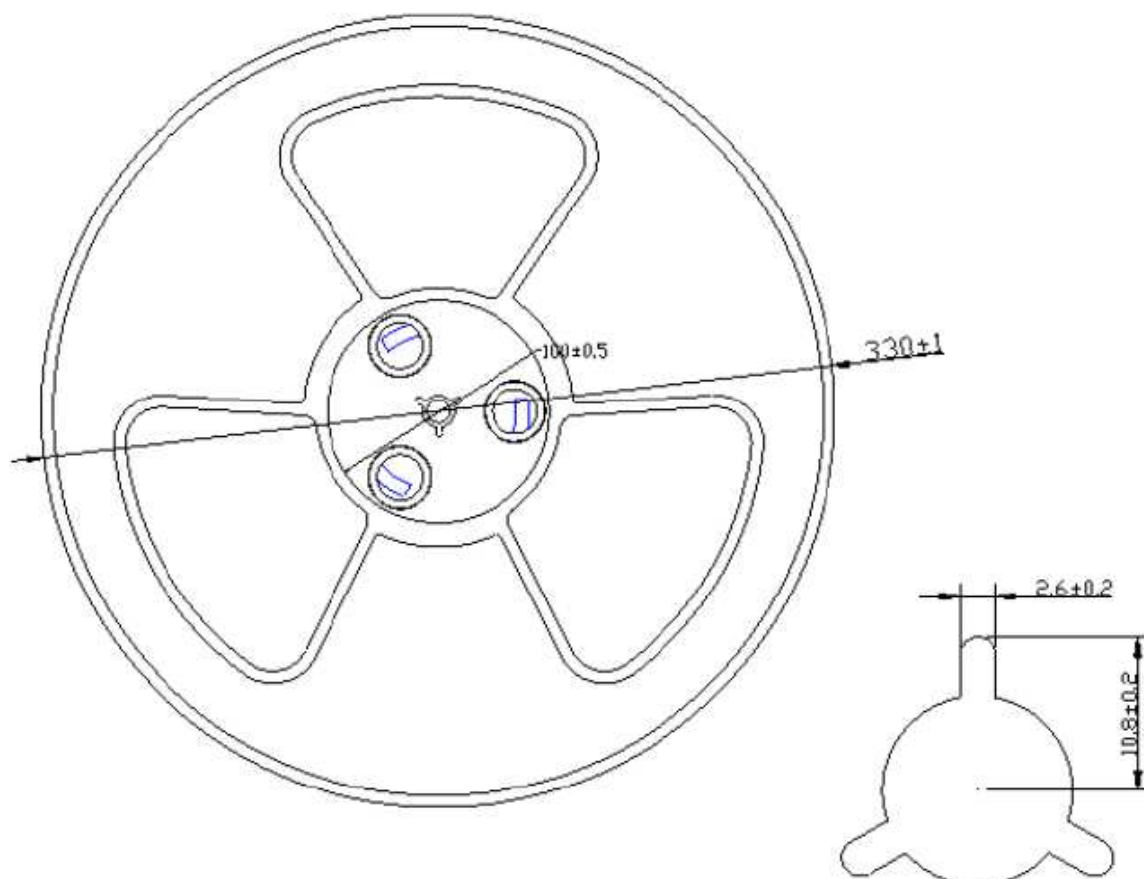
Lot No.:

Z	2	0	1	7	01	24	001
Internal Tracker	Year (2017, 2018,)				Month	Date	Serial

Packaging Information: 2000pcs Per Reel
Tape Dimension


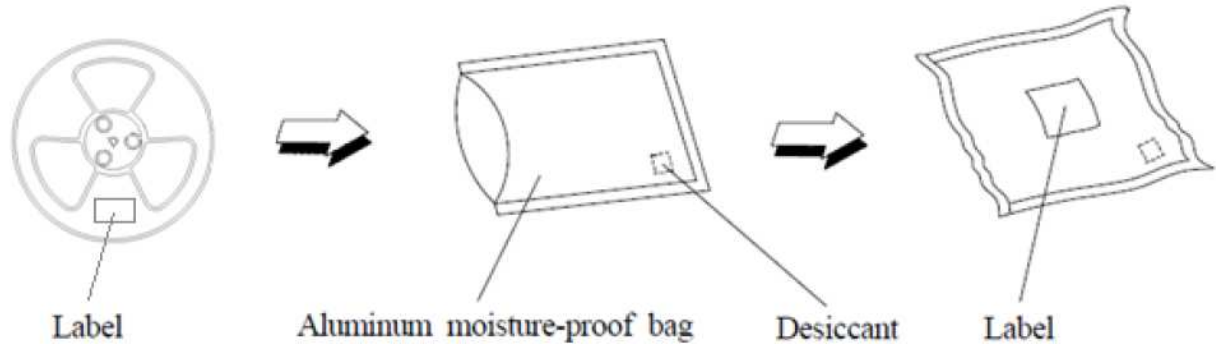
Symbol	A0	B0	K0	P0	P	P2	T
Spec	3.2±0.1	3.7±0.1	3.45±0.1	4.0±0.1	8.0±0.1	2.00±0.1	0.3±0.05
Symbol	E	F	D0	D1	W		
Spec	1.75±0.10	5.50±0.05	1.5±0.1	1.5±0.1	12±0.1		

Reel Dimension



Unit: mm

Packing Dimension



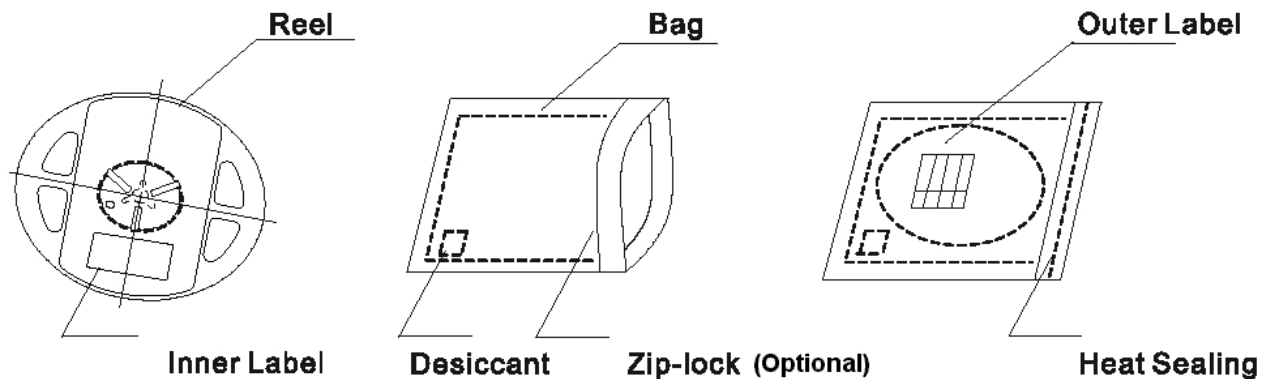
	Specification	Material	Quantity
Carrier tape	Per EIA 481-1A specs	Conductive black tape	2000pcs per reel
Reel	Per EIA 481-1A specs	Conductive black	
Label	IN standard	Paper	
Packing bag	220x240mm	Aluminum laminated bag/ no-zipper	One reel per bag
Carton	IN standard	Paper	Non-specified
Others: Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of Iv, λD and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.			

Dry Pack

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

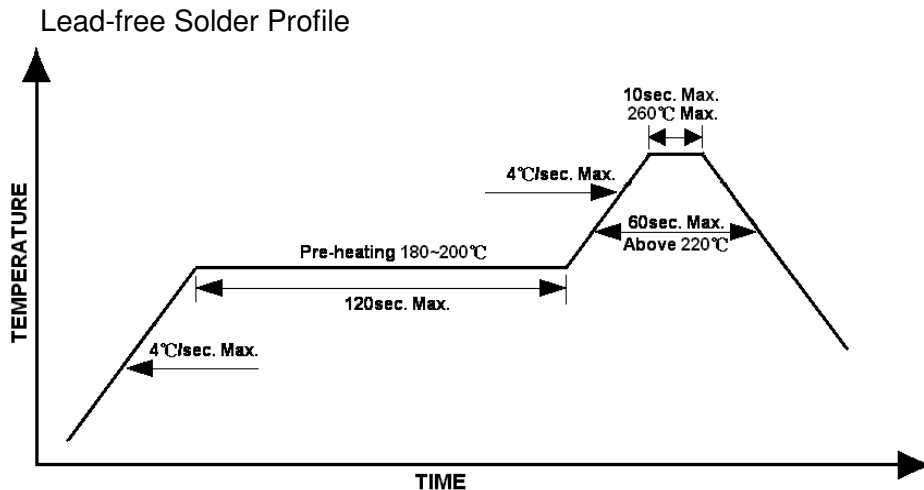
Upon request, a humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

The packaging sequence is as follows:



Reflow Soldering

- Recommended tin glue specifications: melting temperature in the range of 178~192 °C
- The recommended reflow soldering profile is as follows (temperatures indicated are as measured on the surface of the LED resin):



Precautions

- Avoid exposure to moisture at all times during transportation or storage.
- Anti-Static precaution must be taken when handling GaN, InGaN, and AlInGaP products.
- It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage.
- Avoid operation beyond the limits as specified by the absolute maximum ratings.
- Avoid direct contact with the surface through which the LED emits light.
- If possible, assemble the unit in a clean room or dust-free environment.

Reworking

- Rework should be completed within 5 seconds under 260 °C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultra sonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 °C max, <3min

Cautions of Pick and Place

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electro-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.

Reliability

Item	Frequency/ lots/ samples/ failures	Standards Reference	Conditions
Precondition	For all reliability monitoring tests according to JEDEC Level 3	J-STD-020	1.) Baking at 85°C for 24hrs 2.) Moisture storage at 30°C/ 60% R.H. for 192hrs
Solderability	1Q/ 1/ 22/ 0	JESD22-B102-B And CNS-5068	Accelerated aging 155°C/ 24hrs Tinning speed: 2.5+0.5cm/s Tinning: A: 215°C/ 3+1s or B: 260°C/ 10+1s
Resistance to soldering heat		CNS-5067	Dipping soldering terminal only Soldering bath temperature A: 260+/-5°C; 10+/-1s B: 350+/-10°C; 3+/-0.5s
Operating life test	1Q/ 1/ 40/ 0	CNS-11829	1.) Precondition: 85°C baking for 24hrs 85°C/ 60%R.H. for 168hrs 2.) Temp=25°C; IF=30mA; duration 1000hrs
High humidity, high temperature bias	1Q/ 1/ 45/ 0	JESD-A101-B	Temp: 85°C Humidity: 85% R.H., IF=5mA Duration: 1000hrs
High temperature bias	1Q/ 1/ 20	IN specs.	Temp: 55°C IF=30mA Duration: 1000hrs
Pulse life test	1Q/ 1/ 40/ 0		Temp=25°C, If=30mA,, Ip=100mA, Duty cycle=0.125 (tp=125 μ s, T=1sec) Duration 500hrs)
Temperature cycle	1Q/ 1/ 76/ 0	JESD-A104-A IEC 68-2-14, Nb	A cycle: -40 degree C 15min; +85 degree C 15min Thermal steady within 5 min.. 300 cycles 2 chamber/ Air-to-air type
High humidity storage test	1Q/ 1/ 40/ 0	CNS-6117	60+3°C 90+5/-10% R.H. for 500hrs
High temperature storage test	1Q/ 1/ 40/ 0	CNS-554	100+10°C for 500hrs
Low temperature storage test	1Q/ 1/ 40/ 0	CNS-6118	-40+5°C for 500hrs

Revision History

Changes since last revision	Page	Version No.	Revision Date
Initial Release		1.0	02-03-2019

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